## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

nt Application of: Sang Young Kim et al.

MICHOD FOR FILLING CONTACT HOLES WITH METAL BY TWO-STEP DEPOSITION

CONO.: MAY9983 SOI Application No.: 08/327,887

L October 24, 1994

Group Art Unit: 1109

The Assistant Commissioner for Patents

Washington, D.C. 20231

Sir:

Attached herewith are the following items as indicated with an "X":

A Preliminary Amendment (6 pgs). <u>X</u>

 $\underline{\mathbf{X}}$ A return postcard. RECEIVED

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this Transmittal Letter and the paper, as described hereinabove, are being deposited in the United States Postal Service, as first class mail, in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on this 26 day of April, 1995.

MERCHANT, GOULD, SMITH, EDELL, WELTER & SCHMIDT

3100 Norwest Center, Minneapolis, MN 55402

Telephone: 612-332-5300

Name: Robert C. Beck Reg. No.: 28,184

(GENERAL)

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